BGA Heat Sink - High Performance maxiFLOW w/Thermal Tape





ATS Part#: ATS-52190B-C1-R0

Description: 19.00 x 19.00 x 7.50 mm BGA Heat Sink - High Performance maxiFLOW w/Thermal

Tape

Heat Sink Type: maxiFLOW
Heat Sink Attachment: Thermal Tape

Equivalent Part Number: ATS-52190B-C2-R0

*Image above is for illustration purpose only.

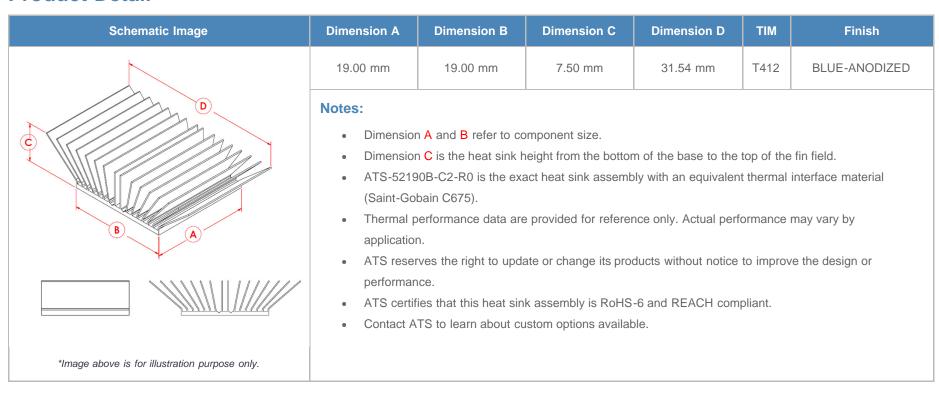
Features & Benefits

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- · Fabricated from extruded aluminum, which minimizes thermal resistance from the base to the fins, reduces weight and keeps costs low
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks

Thermal Performance

| AIR VELOCITY | | @200 LFM 1.0 M/S | @300 LFM 1.5 M/S | @400 LFM 2.0 M/S | @500 LFM 2.5 M/S | @600 LFM 3.0 M/S | @700 LFM 3.5 M/S | @800 LFM 4.0 M/S |
|--------------------|---------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|
| THERMAL RESISTANCE | Unducted Flow | 16.5 °C/W | 13.4 °C/W | 11.6 °C/W | 10.3 °C/W | 9.4 °C/W | 8.7 °C/W | 8.2 °C/W |
| | Ducted Flow | 12.9 | N/A | N/A | N/A | N/A | N/A | N/A |

Product Detail







Mouser Electronics

Authorized Distributor

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Advanced Thermal Solutions:

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